

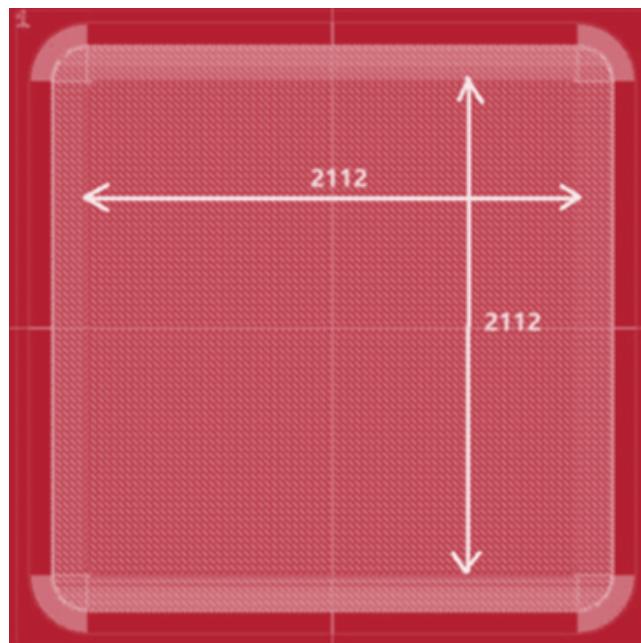
**Features**

- ◆ Zero Forward Recovery Voltage
- ◆ Zero Reverse Recovery Current
- ◆ Excellent Surge Current Capability
- ◆ Temperature Independent Switching
- ◆ Positive Temperature Coefficient on  $V_F$
- ◆ High Frequency Operation

Part NO.	MSD020CS1K2B
$V_{RRM}$	= 1200 V
$I_{F(AVG)}$	= 20 A
$Q_c$	= 125 nC

**Wafer Parameters**

Parameter	Typ.	Unit
Die Size	2800 x 2800	μm
Anode Pad Opening	2112 x 2112	μm
Wafer Diameter	150	mm
Thickness	150±10	μm
Anode Metalization (Al)	4	μm
Cathode Metalization (Ti/Ni/Ag)	0.1/0.4/1	μm
Grossdie	1738	



Maximum ratings

Symbol	Parameter	Test conditions	Value	Unit
$V_{RMM}$	Repetitive peak reverse voltage		1200	V
$I_{F(AVG)}$	Average forward current	$T_c=145^\circ\text{C}$	20*	A
$I_{FSM}$	Non-Repetitive forward surge current	$T_c=25^\circ\text{C}$ , $t_p=10\text{ms}$ , Half Sine Wave	200	A
$P_{tot}$	Power dissipation	$T_c=25^\circ\text{C}$ $T_c=110^\circ\text{C}$	200* 120*	W
$T_j$	Operating junction temperature		-55~175	$^\circ\text{C}$
$T_{stg}$	Storage temperature		-55~175	$^\circ\text{C}$

\* Assumes thermal resistance of  $0.328^\circ\text{C}/\text{W}$  or less

**Electrical Characteristics**Static Characteristics

Symbol	Parameter	Test conditions	Value			Unit
			Min.	Typ.	Max.	
$V_{bc}$	DC blocking voltage	$T_j=25^\circ\text{C}$		1200		V
$V_F$	Diode forward voltage	$I=20\text{A}$ $T_j=25^\circ\text{C}$ $I=20\text{A}$ $T_j=175^\circ\text{C}$		1.35 1.65		V
$I_R$	Reverse current	$V_R=1200\text{V}$ $T_j=25^\circ\text{C}$ $V_R=1200\text{V}$ $T_j=175^\circ\text{C}$		0.5 10		$\mu\text{A}$

AC Characteristics

Symbol	Parameter	Test conditions	Value			Unit
			Min.	Typ.	Max.	
$Q_C$	Total capacitive charge	$V_R=960\text{V}$ $T_j=25^\circ\text{C}$ $Q_C = \int_0^{V_R} C(V) dV$		100		nC
$C$	Total capacitance	$V_R=1\text{V}$ $f=1\text{MHz}$ $V_R=960\text{V}$ $f=1\text{MHz}$ $V_R=1200\text{V}$ $f=1\text{MHz}$ $Z$		1200 120 50		pF
$E_C$	Capacitance stored energy	$V_R=960\text{V}$		13		$\mu\text{J}$